Ceramic Bandpass Filter 50Ω 1400 to 2320 MHz

BFCN-1801+

The Big Deal

- Small size 3.2mm x 1.6mm
- Pass band (1400-2320 MHz)
- High rejection over wide band



Product Overview

The BFCN-1801+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 1400 to 2320 MHz, these units offer excellent rejection over a wide stopband.

Key Features

Feature	Advantages
Small Size (3.20mm x1.6 mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Rejection peaks close to pass band	Provides good rejection of signals close to the pass band, for improved system performance.
Wide stopband	No regrowth at 2nd and 3rd harmonics permits filter to be used in presence of wideband undesired signals.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.

Ceramic **Bandpass Filter**

50Ω

1400 to 2320 MHz

Features

- Small size
- Temperature stable
- · Hermetically sealed
- LTCC construction

Maximum Ratings

Operating Temperature	-55°C to +100°C		
Storage Temperature	-55°C to +100°C		
RF Power Input	1W max.		

Permanent damage may occur if any of these limits are exceeded.

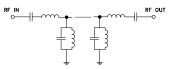


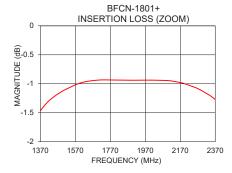
Bottom View 1 ⊠3

Pad Connections

Input	1
Output	3
Ground	2

Functional Schematic





Applications

- Harmonic Rejection
- Transmitters / Receivers

BFCN-1801+



Generic photo used for illustration purposes only CASE STYLE: FV1206-7

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

> Available Tape and Reel at no extra cost Devices/Reel 20, 50, 100, 200, 500,1000, 3000

Electrical Specifications^{1,2} at 25°C

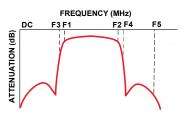
Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Center Frequency	-			1802		MHz
Pass Band	Insertion Loss	F1-F2	1400-2320	_	1.5	3.0	dB
	Return Loss	F1-F2	1400-2320	_	17	_	dB
Stop Band, Lower	Insertion Loss	DC-F3	DC-1000	20	25	_	dB
Stop Band, Upper	Insertion Loss	F4-F5	3110-6700	20	33	_	dB
Stop Band, Opper Insertion Loss		F5-F6	6700-10000	15	24	-	

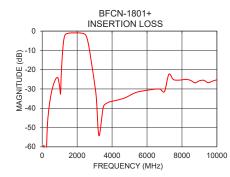
1. Measured on Mini-Circuits Characterization Test Board TB-812+.

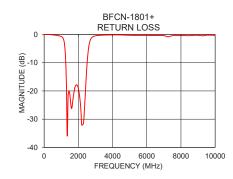
This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.



Specification Definition







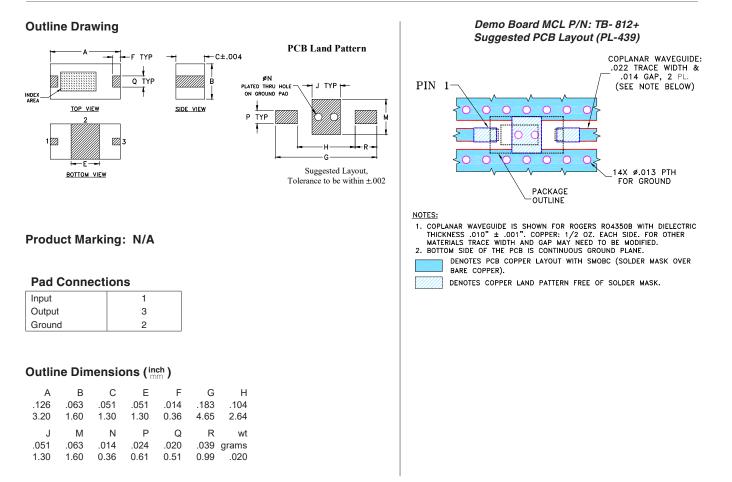
REV. OR ECO-00230 BFCN-1801 BK/CP/AM 200331 Page 2 of 3

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Typical Performance Data at 25°C

Bandpass Filter

BFCN-1801+



Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Ceramic Bandpass Filter

Typical Performance Data

FREQUENCY	INSERTION LOSS	RETURN LOSS
(MHz)	(dB)	(dB)
10	73.63	0.02
55	62.92	0.02
100	59.37	0.00
200	69.27	0.02
300	48.50	0.02
400	38.98	0.09
500	33.17	0.16
600	29.14	0.23
700	26.28	0.32
800	24.47	0.42
900	24.24	0.55
1000	28.91	0.75
1050	32.63	0.94
1077	25.87	1.09
1100	20.80	1.29
1150	12.91	2.07
1200	7.29	4.00
1250	3.78	8.42
1300	2.18	17.34
1350	1.59	35.99
1400	1.36	21.62
1450	1.22	20.01
1488	1.14	20.65
1500	1.12	21.07
1600	0.99	26.24
1700	0.94	22.22
1800	0.94	18.65
1900	0.94	17.82
2000	0.94	19.10
2100	0.95	23.30
2153	0.97	27.30
2200	1.00	32.10
2300	1.13	31.41
2400	1.40	21.84
2500	2.24	11.08
2600	4.82	4.69
2700	9.53	1.98
2800	15.16	1.05
2900	21.08	0.69
2976	25.78	0.54
3100	34.71	0.42
3250	54.25	0.33
3500	39.25	0.24
3750	37.12	0.20
4000	36.39	0.18
4250	35.87	0.17
4500	35.30	0.20
4750	34.56	0.25
5000	33.44	0.30
5250	32.25	0.35
5500	31.47	0.35
5750	31.06	0.34
6000	30.67	0.34

BFCN-1801+



30.33

30.05

30.10

31.32

22.41

25.07

25.44

25.28

25.00

25.58

26 81

25.76

25.50

26.73

25.91

25.25

0.37

0.38

0.39

0.41

0.84

0.44

0.41

0.40

0.42

0.45

0.33

0.32

0.48 0.28

0.27

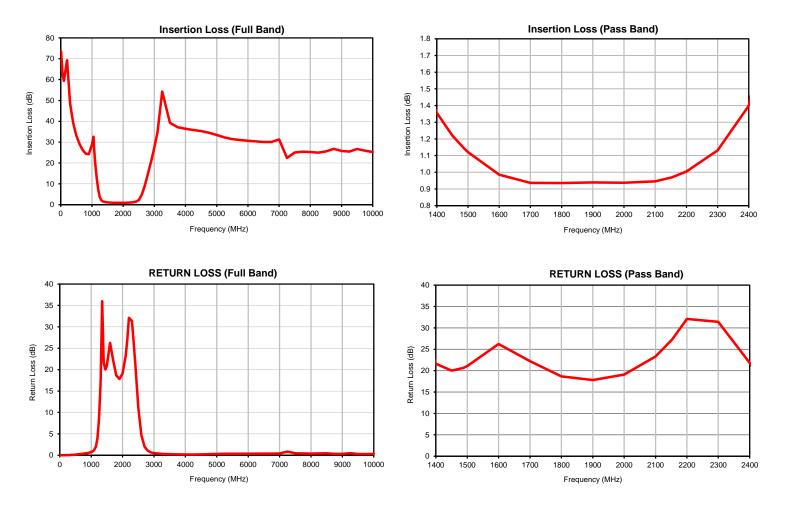
0.32



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IF/RF MICROWAVE COMPONENTS







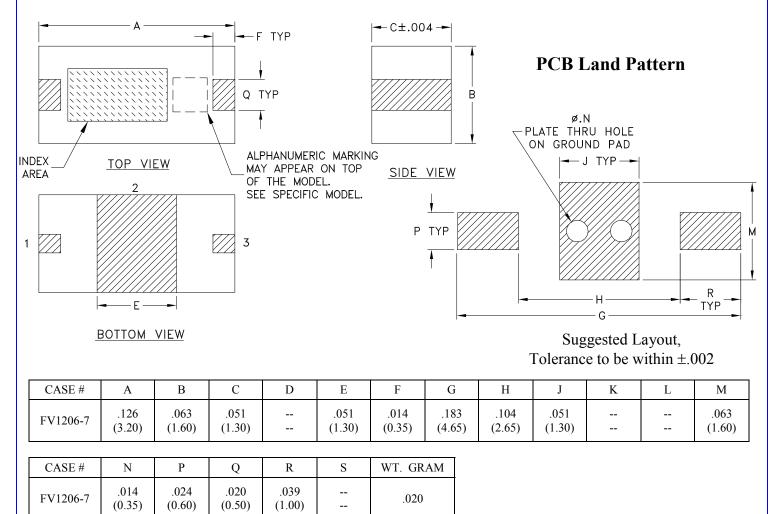
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Case Style

FV1206-7

Outline Dimensions



Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Open style, ceramic base.
- Termination finish: as shown below or indicated on Data Sheet. For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix. For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- 3. Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.





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RF/IF MICROWAVE COMPONENTS

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Tape & Reel Packaging

<u>TR-F75</u>

DEVICE ORIE	INTATION IN T&F	<u>}</u>					
DI	EVICE	Applicable Case Styles					
- C/		ILLUSTRATION 1	FV1206-1 FV1206-3				
DIRECTIC	ON OF FEED						
	EVICE AVITY ITCH INDEX TERMINATION AREA	ILLUSTRATION 2	Applicable FV1206-4 FV1206-5 FV1206-6 FV1206-7 FV1206-9	Case Styles			
-	FV1206-11 FV1206-12						
			GE0805C-18				
			NL1008C-6 NL1008C-7				
			NL1008C-9				
DIRECTI	ON OF FEED		NL1008C-10				
		ILLUSTRATION 3					
Tape Width, mm	Device Cavity	Devices p	ber Reel				
• ′	Pitch, mm	Reel Size, inches					
			Small	20			
			quantity	50			
			standards	100			
8	4	7	(see note)	200			
				500			
			~	1000			
			Standard	3000			

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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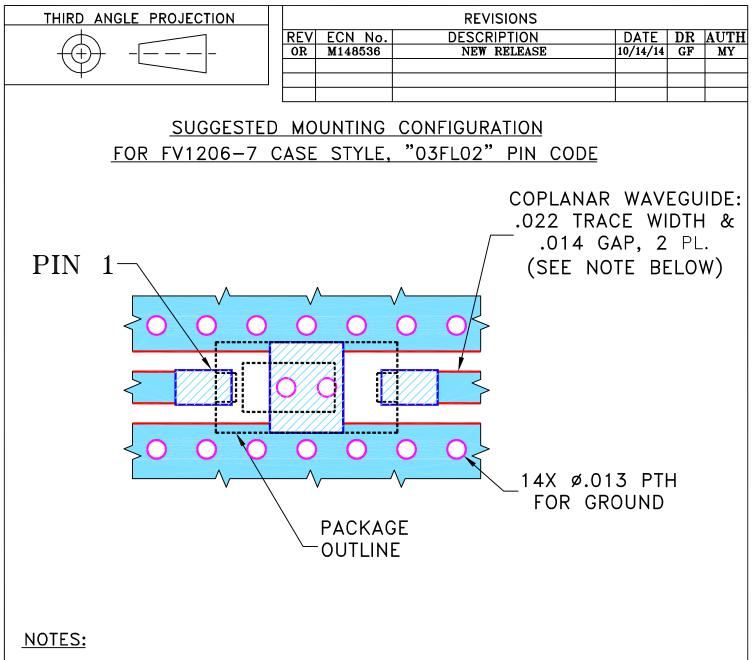
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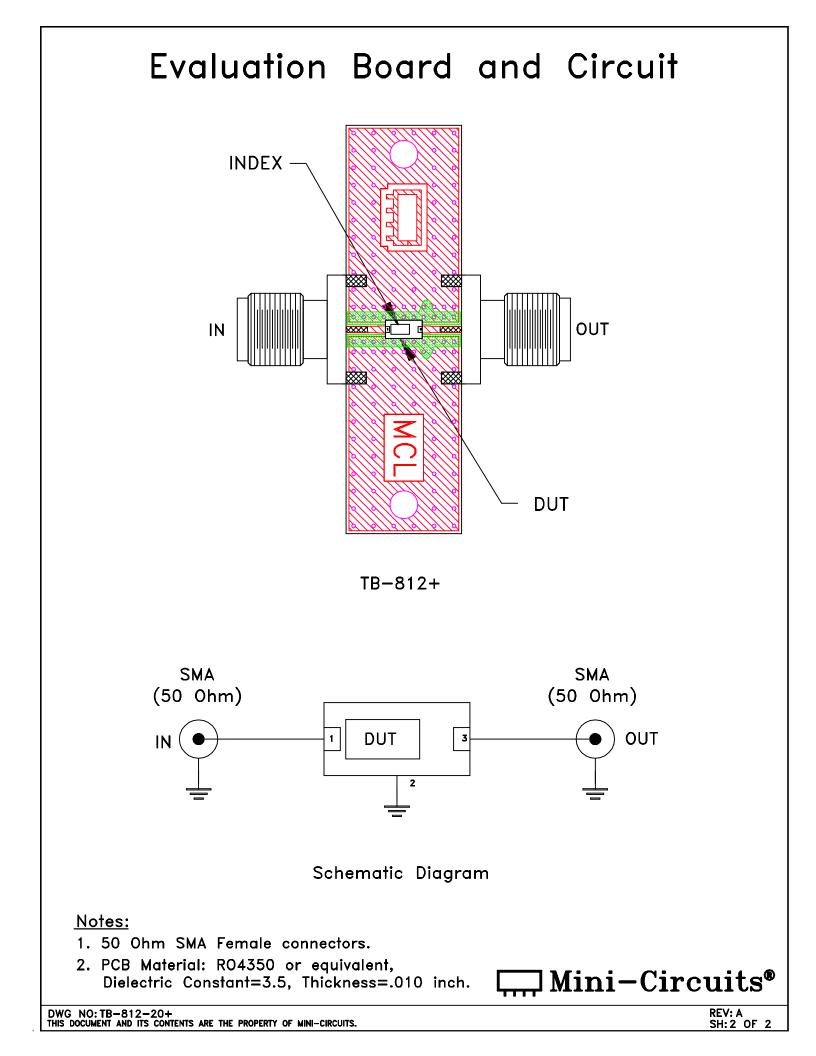


- COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010" ± .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 - DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER

BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			∃ ъ σ • • •		N •	• R			
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3 PL DECIMALS ± .005	APPROVED	MY	10/14/14									
FRACTIONS ±] P	L.	03FLC)2.	FV1206	5 - 7.	TB-	81	2+
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Mini-Circuits

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec		
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet		
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet		
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours		
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1		
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage		
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D		
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A		

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